



Product Change Notice

PCN Number: 13-0832-04R
Issue Date: 20-NOVEMBER-2013

Exar Corporation

www.exar.com | Support: customersupport@exar.com

PRODUCTS AFFECTED:

XRT86VX38IB329-F
XRT86VX38IB256-F

CHANGE CATEGORY:

- | | | |
|--|---|---|
| <input checked="" type="checkbox"/> Material | <input type="checkbox"/> Process | <input type="checkbox"/> Package |
| <input checked="" type="checkbox"/> Design | <input checked="" type="checkbox"/> Datasheet | <input type="checkbox"/> Packing/Shipping |
| <input type="checkbox"/> Other (specify) | | |

DESCRIPTION OF CHANGE:

1. Qualified copper wire bonding assembly in addition to currently qualified gold wire bonding assembly in UTAC, China.
2. Changed die revision from A to B that includes bond pad changes for copper bond wires [Revision ID value in register 0x01FF is changed to 0x02].

IMPACT OF CHANGE:

There is no change to product form, fit or function. There is a change to the value of Rev ID register.

TARGET IMPLEMENTATION DATE: 20-FEBRUARY-2014

Please contact customer support (customersupport@exar.com) for sample date availability or qualification data

PROPRIETARY INFORMATION

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